Mini-Lock Wire-to-Board Connector System >

The versatile and proven 2.50mm pitch Mini-Lock Wire-to-Board/Wire-to-Wire Connector system extends design options to include vertical and right-angle SMT headers, with terminal position assurance (TPA) retainer and Glow-Wire through-hole vertical header options

FEATURES AND ADVANTAGES



Terminal Position Assurance (TPA) Ensures that wires are fully inserted

Receptacle Housing: 51163 TPA: 51164



Terminal Position Assurance feature

Seats the crimp terminal fully in the receptacle housing to reduce terminal backout

Glow Wire compliance

Meets global safety and environmental requirements

SMT Header Terminals

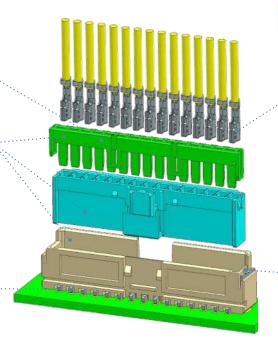
Allow quick, automated mounting assembly on the PCB when used as a vertical header



Locating Peg (Boss) Mitigates the misalignment by assisting in right mount orientation

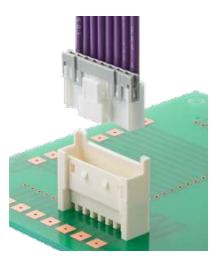
Kinked Pins

Provide secure header retention on the PCB before soldering



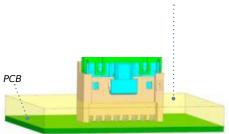
Series 215931 SMT Vertical Header 2 to 15 circuits

molex





Potting treatment (Height 2.00 to 6.00mm) Protects the components on PCB from dust and water



Header for Potting: 53517xx30

Use of Popular Crimp Terminals Enables easy access to crimp applicators that are readily available in the market



SMT Solder Tabs Enable robust retention on the PCB when mounted as a rightangle header (in which case a different series number, 215932 is assigned)

molex

Mini-Lock Wire-to-Board Connector System >

APPLICATIONS

Home Appliance Refrigerators Washers and dryers Air conditioners

Industrial Automation equipment Vending machines

Consumer

Fitness equipment Gaming machines Security systems

Automotive

Interior/exterior lightings Audio equipment Navigation systems



Washers and dryers



Refrigerators



Vending Machines

SPECIFICATIONS

REFERENCE INFORMATION

Packaging: Refer to Packaging Specifications UL File No.: E29179 CSA File No.: LR19980 Designed In: Millimeters RoHS: Yes Halogen Free: No Glow Wire Compliant: Yes

ELECTRICAL

Voltage (max.): 250V Current (max.): Refer to Current Derating Reference Information Contact Resistance (max.): 20 milliohms Dielectric Withstanding Voltage: 1000V AC/ min Insulation Resistance (min.): 1000 Megohms

MECHANICAL

Contact Insertion Force (max.): 9.8N Contact Retention to Housing (min.): 14.7N Mating Force (max.): 58.8N (8 circuit) Unmating Force (min.): 7.9N (8 circuit) Durability (max.): 30 cycles

PHYSICAL

Housing: PBTP UL94V-O (51163, 51164, 53375, 53426) PA66 UL94V-O (53517) PA9T UL94V-O (215931, 215932) Contact: Phosphor Bronze Plating: Pre-Tin Contact Area (min.)- 0.9 micrometer Header Pin: Phosphor Bronze Plating: Pre-Tin Contact Area (min.) - 1.0 micrometer Operating Temperature: -40 to+ 105°C

molex

Mini-Lock Wire-to-Board Connector System >

CURRENT DERATING REFERENCE INFORMATION

AWG	2-circuits	7-circuits	15-circuits
	Amps (A)	Amps (A)	Amps (A)
20	5.0	3.5	3.5
22	4.5	3.0	3.0
24	4.0	2.5	2.5
26	3.5	2.5	2.0

(1) Values are for REFERENCE ONLY.

(2) Current derating values are based on temperatures not exceeding 30°C.

(3) PCB trace design can greatly affect temperature rise results in wire-to-board applications.

(4) Data is for all powered circuits.

(5) All data are interpolated information.

ORDERING INFORMATION

Series No.	Components	AWG or Circuits	Glow Wire Compliant
<u>50752</u>	Crimp Terminal	20 to 26 AWG	-
<u>51163</u>	Receptacle Housing	2 to 15	Yes
<u>51164</u>	TPA Retainer		Yes
<u>53517</u>	Vertical Header for Potting, H=17.5mm,Through Hole		Yes
<u>53375</u>	Vertical Header, H=11.5mm, Through Hole		No
<u>53476</u>	Vertical Header, H=11.5mm, Through Hole		Yes
<u>53426xx10</u>	Right Angle Header, Through Hole		No
<u>534269xx0</u>	Right Angle Header, Through Hole		Yes
<u>215931</u>	Vertical Header, SMT		Qualification in process
<u>215932</u>	Right Angle Header, SMT		Qualification in process

www.molex.com/link/minilock.html